

What is claimed is:

1. A method for cutting a glass substrate member comprising:
a removing step for removing a part or whole of a back
surface portion of the glass substrate member; and
5 a scribing step for forming a scribe line that produces a
crack on a front surface of the glass substrate member, said crack
extending to a back surface of the glass substrate member.
2. The method for cutting a glass substrate member according
10 to claim 1, wherein: said removing step comprises removing the back
surface portion of the glass substrate member through application of
etching or chemical treatment such as chemical polishing.
3. The method for cutting a glass substrate member according
15 to claim 1 or 2, wherein: said scribing step comprises moving a tool
coming in contact with the glass substrate member over the front
surface of the glass substrate member, while vibrating same in a
direction intersecting the front surface of the glass substrate
member.
- 20 4. The method for cutting a glass substrate member according
to claim 3, wherein: said scribing step comprises forming a plurality
of scribe lines, which are in parallel to each other so as to intersect
at right angles.
- 25 5. The method for cutting a glass substrate member according

to claim 3, wherein: said scribing step comprises forming the scribe line in a form of a closed curve.

6. The method for cutting a glass substrate member according to any of claims 1 to 5, wherein: said removing step comprises removing only the part corresponding to the scribe line.

7. A method for cutting glass substrate members comprising:
a removing step for removing a part or whole of each back surface portion of two glass substrate members;
a step for stacking the two glass substrate members so that back surfaces of the two glass substrate members face to each other; and
a scribing step for forming a scribe line that produces a crack on each front surface of the stacked glass substrate members, said crack extending to a back surface of each of the glass substrate members.

8. The method for cutting a glass substrate member according to any of claims 1 to 7, wherein the glass substrate member is a glass substrate member for a liquid crystal display or an organic EL display.